

PTP83216BT18

SMD Type Phototransistor with Daylight Filter

Features

- Small double-end package
- High photo sensitivity
- High reliability
- Spectral range of sensitivity: 700-1100nm
- Fast Response time
- RoHS compliance

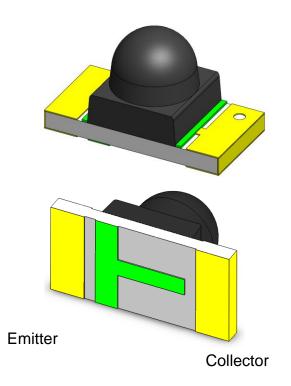
Applications

Infrared sensor

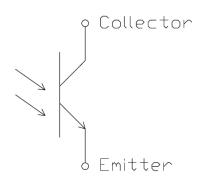
Description

The PTP83216BT18 is silicon NPN Phototransistor housed in a miniature SMD package. The device comes with a superior filtering for visible light by utilizing special black molding compound.

Package Outline



Schematic





Absolute Maximum Rating at 25°C

Symbol	Parameters	Ratings	Units	Notes
lc	Collector Current	20	mA	
BVCEO	Collector-Emitter Voltage	35	V	1
B _{VECO}	Emitter-Collector Voltage	5	V	2
T _{opr}	Operating Temperature	-40 ~ +85	٥C	
T _{stg}	Storage Temperature	-40 ~ +100	٥C	
T _{sol}	Soldering Temperature	260	0C	3
Pto	Total Power Dissipation	150	mW	

Optical Characteristics

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
λ	Spectral Bandwidth	-	700	-	1100	nm	
λP	Peak Sensitivity	-	-	880	-	nm	
θ1/2	View Angle	V _{CE} =5V	-	±15	-	deg	

Electrical Characteristics

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
1	Dark Current	Ee=0mW /cm ²	-	-	100	nA	
ICEO		V _{CE} =20V					
	Collector-Emitter	Ee=1mW /cm ²		-	0.4	V	
V _{CE(sat)}	Saturation Voltage	Ic=1.4mA	-				
	Collector Linkt Current	Ee=1mW /cm ²	1.4	2.8	6.4	mA	4
lc	Collector Light Current	$\lambda_P=940$ nm, V _{CE} =5V					4
Ст	Terminal Capacitance	Ee=0mW /cm ²	-	3.80	-		
		f=1MHz ,V _{CE} =5V				pF	



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Switching Characteristics

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
tr	Rise Time		-	6	-		
t _f	Fall Time	$V_{ce} = 5V, R_L = 100\Omega$	-	7	-		F
t _{on}	Turn on Delay Time	Ic=1.0mA	-	11	-	μs	5
t _{off}	Turn off Delay Time		-	7.9	-		

Notes:

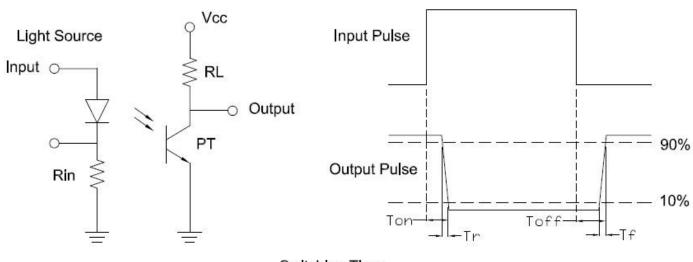
- 1 : Test conditions : I_C =100µA, Ee=0mW/cm².
- 2 : Test conditions : I_E =100µA, Ee=0mW/cm².
- 3 : Soldering time \leq 5 seconds.

$4:I_C$ Bin Rank :

Bin Code	P3	P4	P5
Min	1.4	2.0	3.2
Max	2.8	4.4	6.4

5 : Test circuit:

Detector

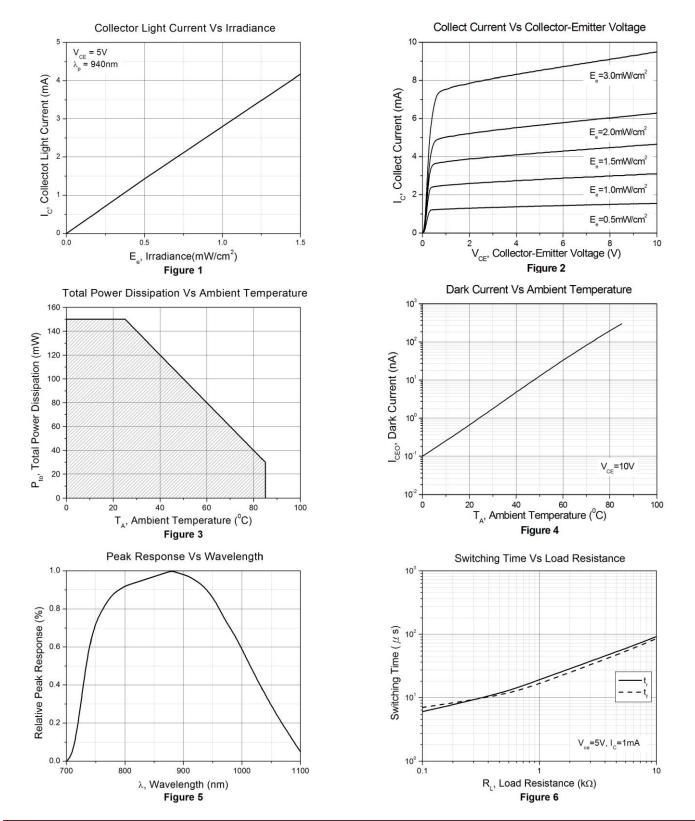


Switching Time



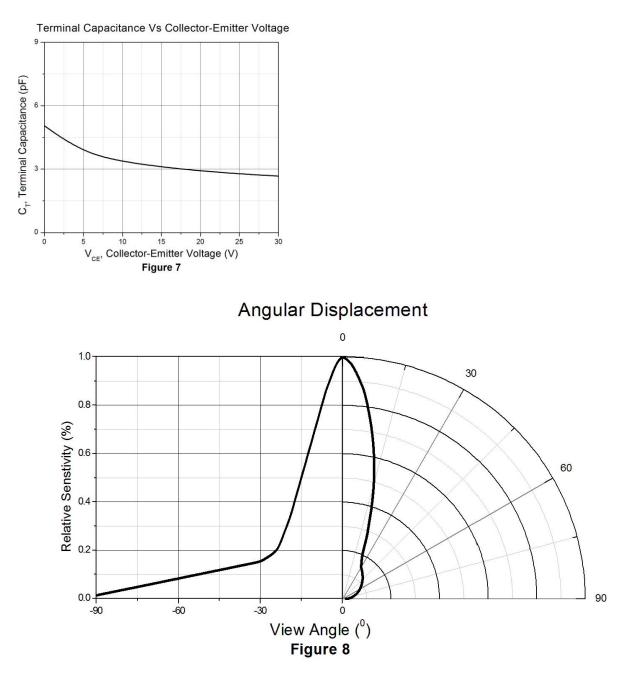
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Typical Characteristic Curves



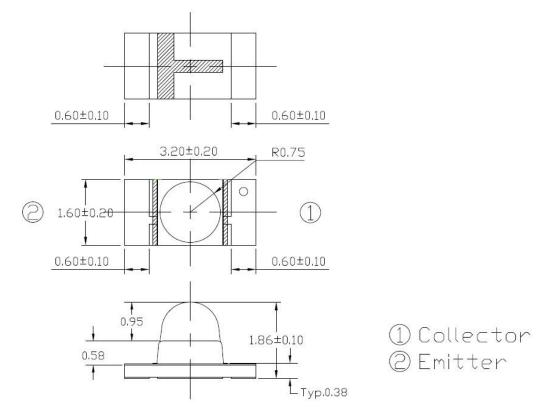


Typical Characteristic Curves

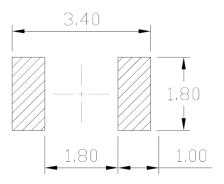




Package Dimension All dimensions are in mm, unless otherwise stated



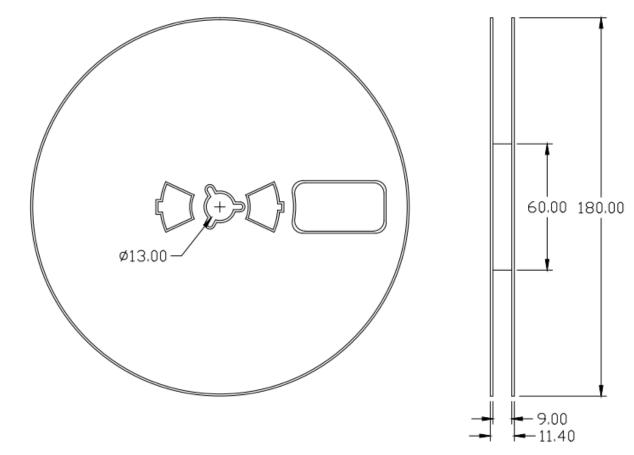
Recommended Soldering Mask All dimensions are in mm, unless otherwise stated



Ordering Information

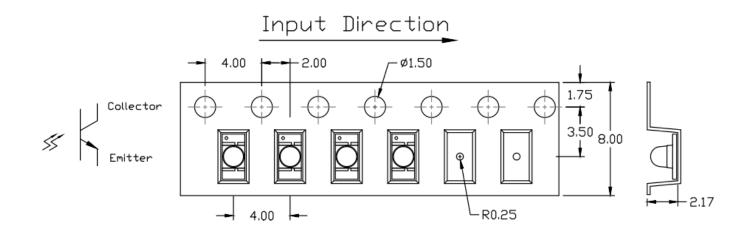
Part Number	Description	Quantity
PTP83216BT18	Tape & Reel	2000 pcs





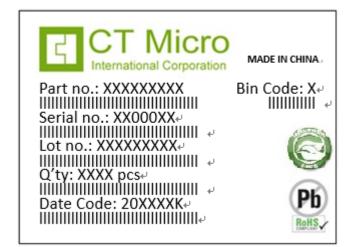
Reel Dimension All dimensions are in mm, unless otherwise stated

Tape Dimension All dimensions are in mm, unless otherwise stated





Label Form Specification



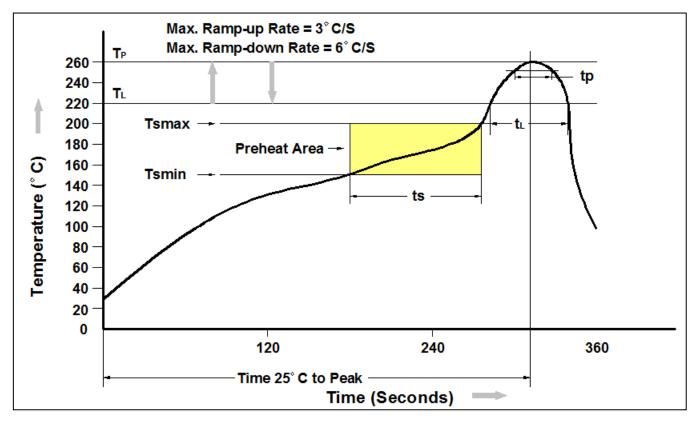
Part no: CTM Production Number Serial no: Production Number Lot no: Lot number Q'ty: Packing Quantity Date Code: Manufacture Date Bin Code: Ic Ranks MADE IN CHINA: Production Place

Storage Condition

- 1. Do not open moisture proof bag before the products are ready to use.
- 2. The moisture barrier bag should be stored at 30°C and 90%R.H. max. before opening. Shelf life of non-opened bag is 12 months after the bag sealing date.
- 3. After opening the moisture barrier bag floor life is 168h at 30°C/60%RH. max. Unused LEDs should be resealed into moisture barrier bag. (Refer to J-STD-020 Standard)
- 4. If the moisture absorbent material has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the J-STD-033 Standard conditions.



Reflow Profile



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Ramp-up Rate (t∟ to t _P)	3°C/second max.
Liquidous Temperature (TL)	217°C
Time (t _L) Maintained Above (T _L)	60 – 150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (t _P) within 5°C of 260°C	30 seconds
Ramp-down Rate $(T_P \text{ to } T_L)$	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.



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